

# SILICON SWITCHING DIODE 1SS304

## HIGH SPEED SWITCHING SILICON EPITAXIAL DOUBLE DIODE : COMMON CATHODE

#### **FEATURES**

- Low capacitance: Ct = 1.1 pF TYP.
- High speed switching: trr = 3.0 ns MAX.
- Wide applications including switching, limitter, clipper.
- Double diode configuration assures economical use.

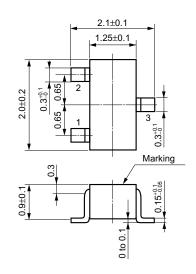
#### ABSOLUTE MAXIMUM RATINGS

Maximum Voltages and Currents (T<sub>A</sub> = 25°C)

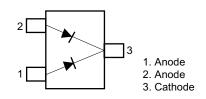
	Peak Reverse Voltage	$V_{RM}$	75	V
	DC Reverse Voltage	$V_{R}$	50	V
	Surge Current (1 μs) Note	IFSM	6.0	Α
	Surge Current (1 µs)	IFSM	4.0	Α
	Peak Forward Current Note	<b>I</b> FM	450	mA
	Peak Forward Current	Iғм	300	mA
	Average Rectified Current Note	lo	150	mA
	Average Rectified Current	lo	100	mA
Maximum Temperatures				
	Junction Temperature	$T_j$	150	°C
	Storage Temperature Range	T <sub>stg</sub>	-55 to + 150	°C
Thermal Resistance				
	Junction to Ambient Note	Rth(j-a)	1.0	°C/mW
	Junction to Ambient	$R_{th(j-a)}$	0.85	°C/mW

Note Both diodes loaded simultaneously.

#### PACKAGE DIMENSIONS (Unit: mm)



#### **CONNECTION DIAGRAM (Top View)**



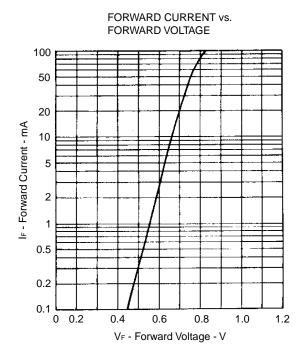
Marking: A6

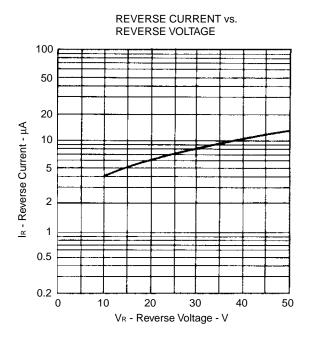
#### **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

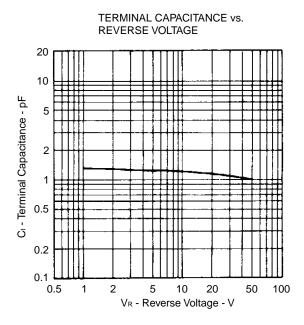
		,				
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Forward Voltage	V <sub>F1</sub>	IF = 10 mA		0.67	1.0	V
	V <sub>F2</sub>	IF = 50 mA		0.75	1.1	V
	V <sub>F3</sub>	IF = 100 mA		0.85	1.2	V
Reverse Current	IR	VR = 50 V			0.1	μΑ
Capacitance	Ct	V <sub>R</sub> = 0 V, f = 1.0 MHz		1.1	4.0	pF
Reverse Recovery Time	trr	See Test Circuit.			3.0	ns

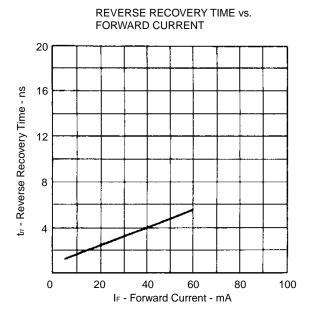
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#### TYPICAL CHARACTERISTICS (TA = 25°C)



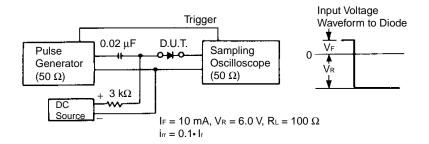


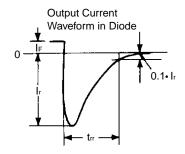






### REVERSE RECOVERY TIME (trr) TEST CIRCUIT





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